

42nd RD50 Workshop – 21st June 2023

Gain degradation study after neutron and proton irradiations in Low Gain Avalanche Diodes

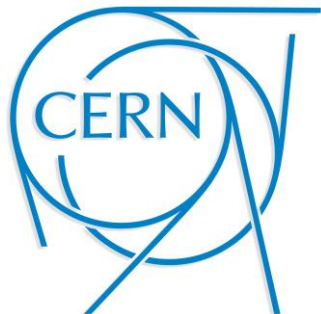
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[arXiv:2306.11760](https://arxiv.org/abs/2306.11760)

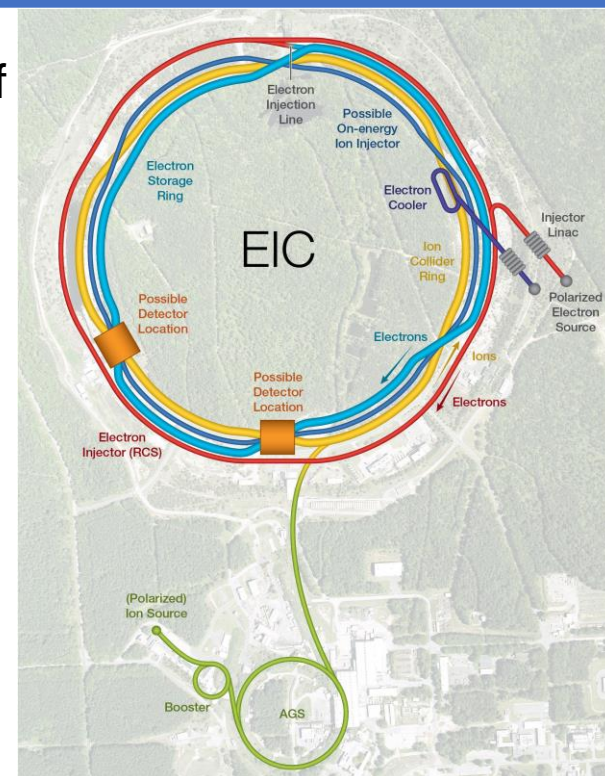
fasih.zareef@cern.ch



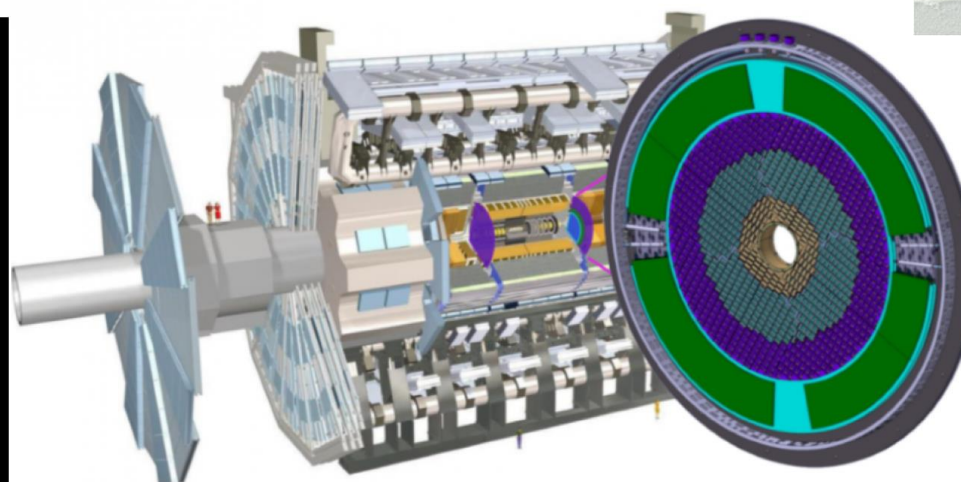
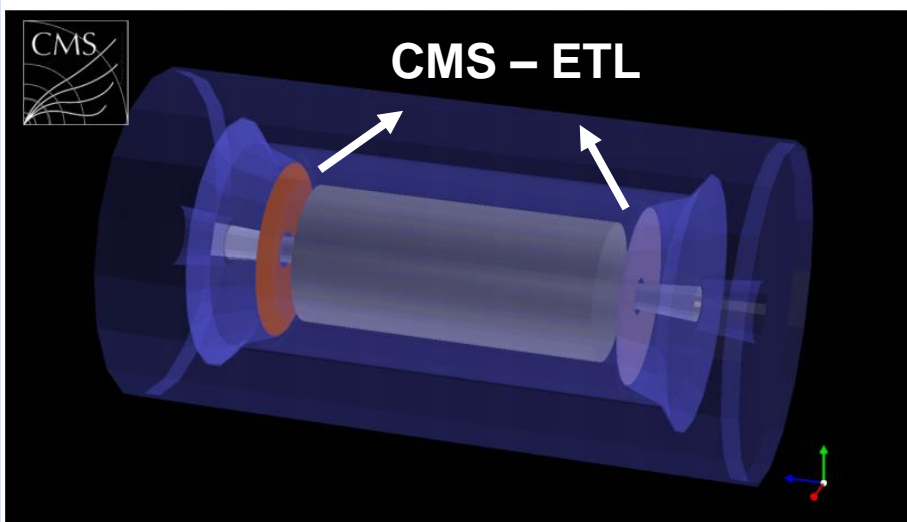
- Motivation and challenges
- Low Gain Avalanche Diodes (LGADs)
- Devices under test
- Electrical Characterizations
 - Reverse Current Damage Coefficient
 - IV and CV Measurements
- Laser Characterizations
 - Gain Measurements
- Gain Layer Degradation Study
 - V_{GL} Extraction
 - Acceptor Removal Coefficient
- Summary and Future Work

Motivation

- To study the **radiation damage** of LGADs for the HL-LHC MIP timing detectors of CMS and ATLAS
- To study the comparison between radiation damage introduced by **neutrons** and **high energy protons**
- A very limited literature on the study of **24 GeV/c** protons on the devices from HPK-P2 and CNM-12916
- Comparison of the sensors from different productions: **HPK-P2** and **CNM-12916**



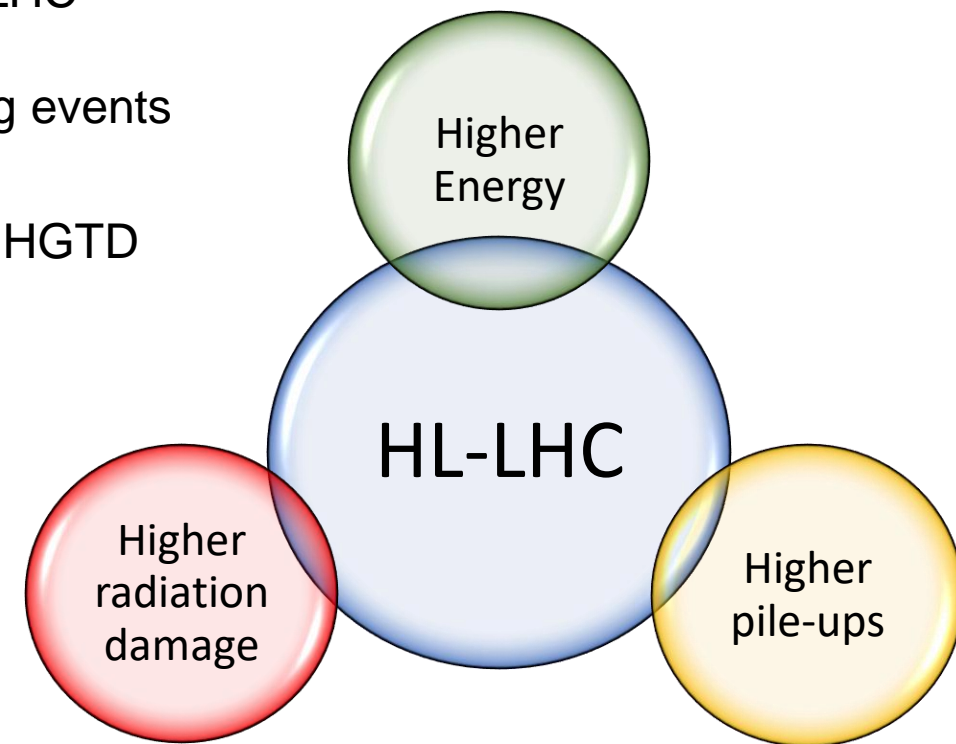
**Electron – Ion Collider
at BNL**



ATLAS – HGTD

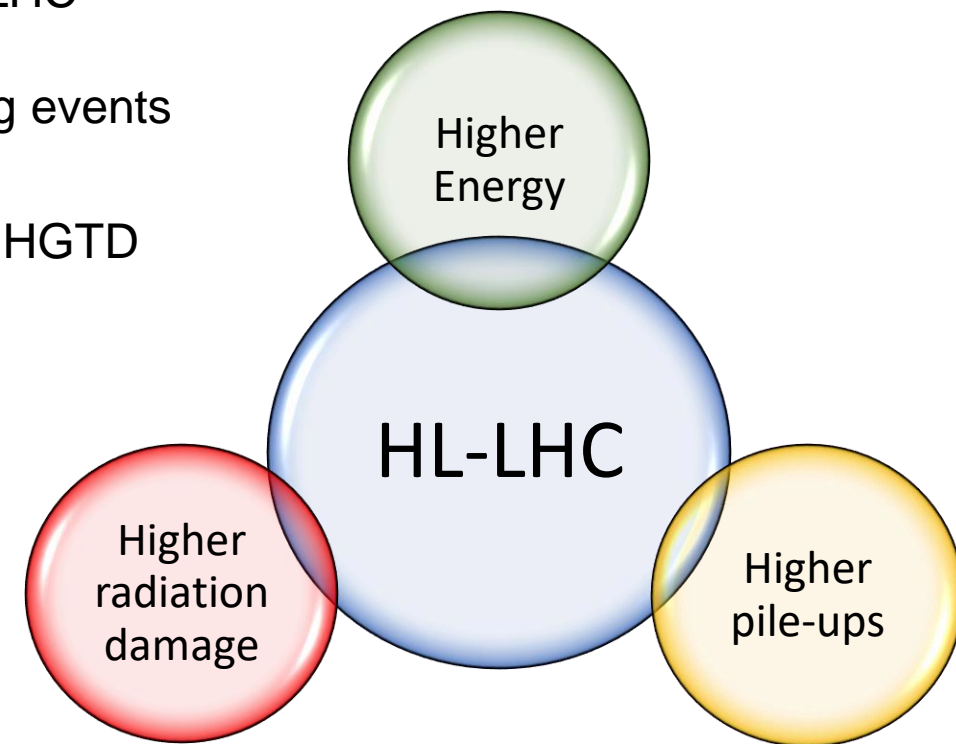
The Need for New Timing Detectors

- **Pile-up** is one of the major challenges for tracking at the HL-LHC
- Timing information will be used to disentangle the overlapping events
- Radiation tolerance up to $\sim 2.5 \times 10^{15} n_{eq} cm^{-2}$ for ATLAS – HGTD
and $\sim 1.5 \times 10^{15} n_{eq} cm^{-2}$ for CMS – ETL is required
- Time resolutions $< 50ps$ per-hit for a MIP



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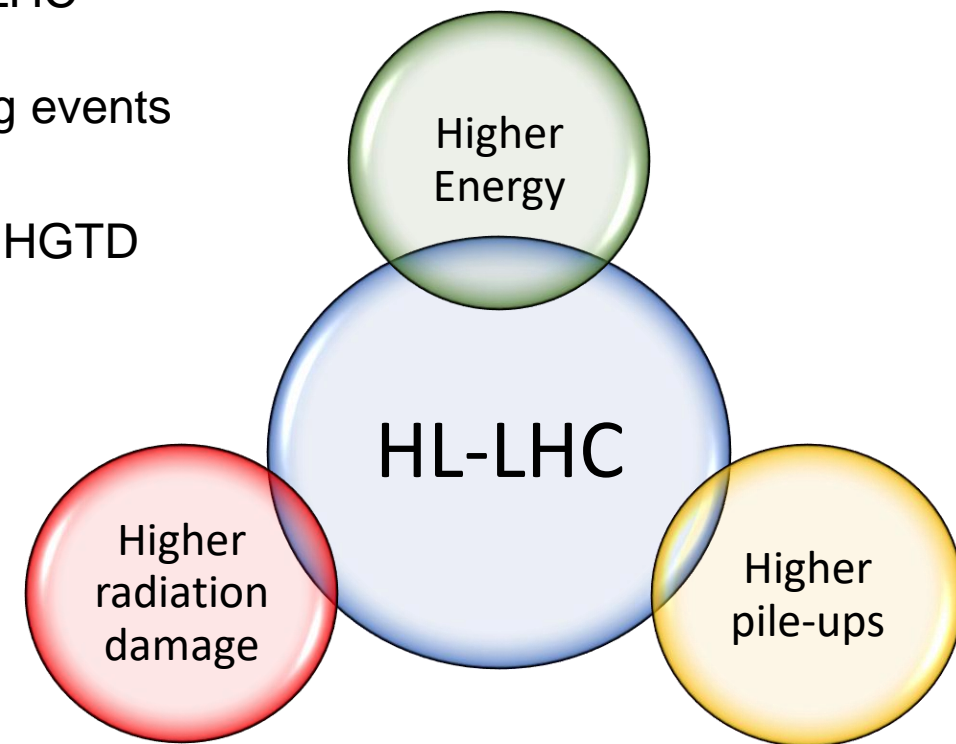
FCC-hh

- Pile up mitigation ~ 1000
- Time resolution ~ 10 ps per-hit for a MIP
- Much higher radiation tolerance $\sim 10^{17} n_{eq} cm^{-2}!!!$

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ATLAS-HGTD and CMS-ETL will be using LGADs as timing detectors

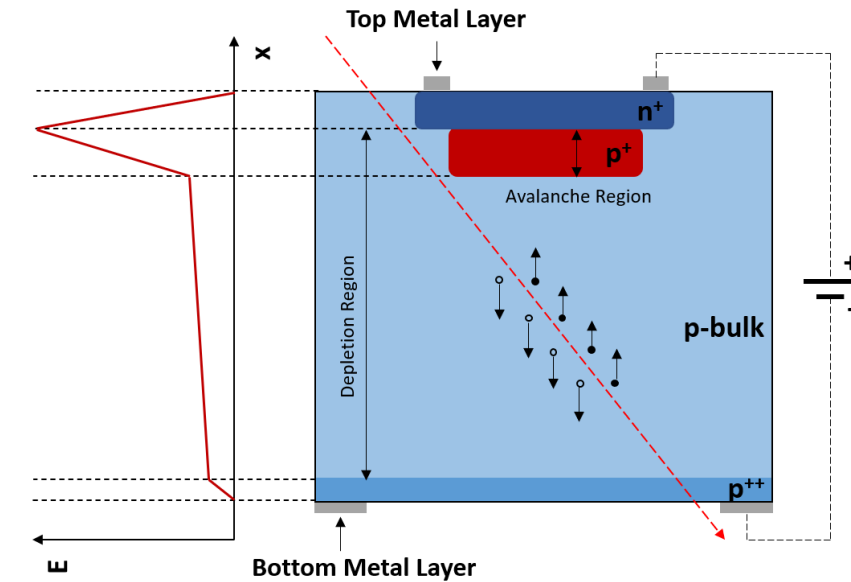


FCC-hh

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Low Gain Avalanche Diodes (LGADs)

- **Low Gain Avalanche Diode**, a detector with:
 - Internal charge multiplication
 - Improved signal-to-noise ratio (SNR)
 - Improved timing capabilities ($< 30\text{ps}$) achievable with thin – LGADs ($50\mu\text{m}$)
 - Low to moderate gain (a few 10s) provided by p^+ multiplication layer
- **Gain depends on:**
 - Doping profile and concentration of the dopant in gain layer (GL)
 - Bias voltage
 - Temperature
- **Producers:**
CNM (Barcelona, ES), FBK (Trento,IT), **HPK (Japan)**, IHEP-NDL and IME (China), Micron(UK), BNL(USA), CIS(Erfurt, Germany) ...

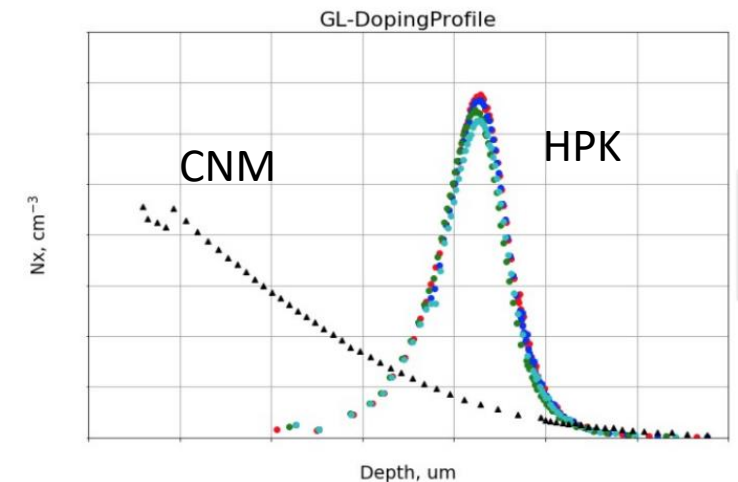
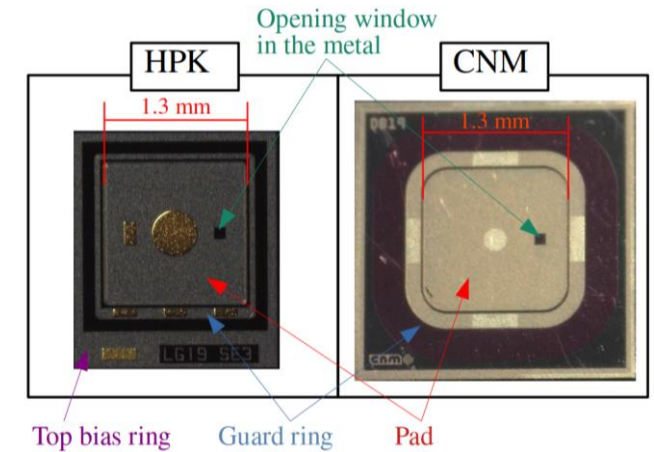


Devices Under Test

- **HPK – Prototype2:**
 - 1.3 x 1.3 mm² pad-like LGADs with 48μm thick epitaxial layer.
 - Gaussian profile doping -> deep.
 - 150μm low resistivity support wafer
- **CNM – 12916:**
 - 1.3 x 1.3 mm² pad-like LGADs with 42μm thick FZ wafer.
 - Narrow and highly doped implant, but also shallow.
 - 300μm low resistivity Czochralski support wafer
- **Neutron irradiation** took place in TRIGA-II Reactor, JSI Ljubljana and the fluences are 4e14, 8e14, and 1.5e15 n_{eq}/cm².
- **24 GeV/c Proton irradiation** was carried out at IRRAD Facility, CERN and the fluences are 4.3e14, 1.18e15, and 1.55e15 n_{eq}/cm² (Hardness factor = 0.62)

Parameters of the LGADs used in this work

Sample	V _{dep} [V]	V _{gl} [V]	V _{bd} (20°C) [V]	C _{end} [pF]	d [μm]
HPK-P2	61.7	54.5	145	3.6	48
CNM12916	42.8	39.4	80-100	4.2	42



All devices were annealed after irradiation at 60°C for 80 minutes

Reverse Current Damage Coefficient (α)

- Volume considered:
 - HPK2:** (1.3x1.3) mm² x 48μm
 - CNM12916:** (1.3x1.3) mm² x 42μm
- Pad current measured after full depletion at 50V.

For Neutrons:

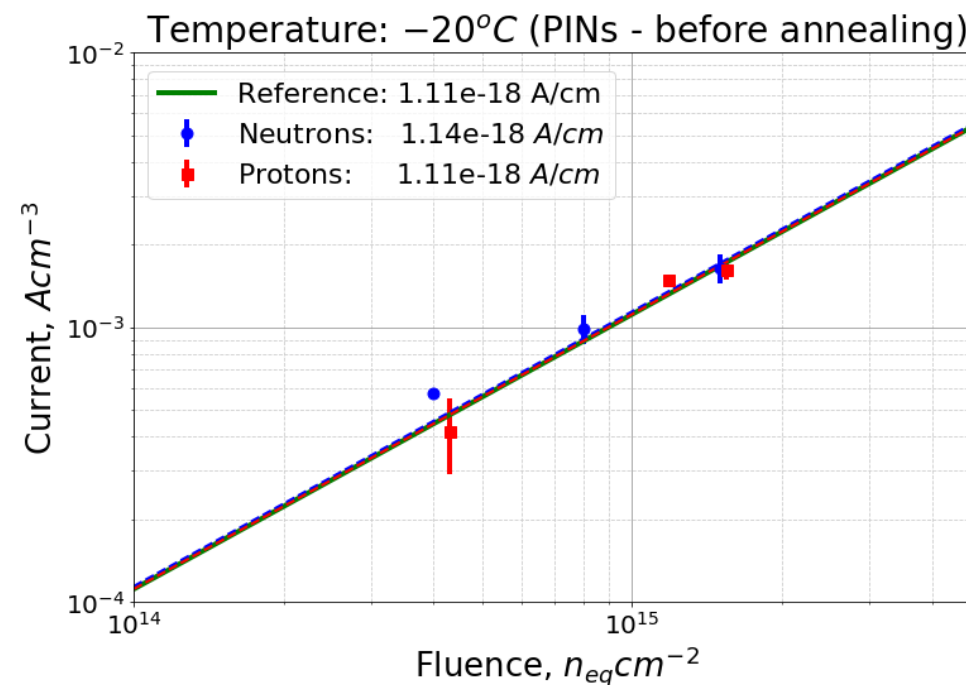
$$\alpha = 1.14 \times 10^{-18} \text{ A/cm}^{-3}$$

For Protons:

$$\alpha = 1.11 \times 10^{-18} \text{ A/cm}^{-3}$$

Reference:

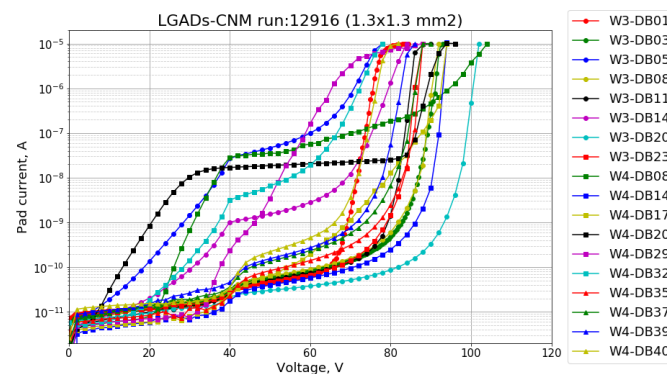
$$\alpha = 1.11 \times 10^{-18} \text{ A/cm}^{-3} \text{ [2]}$$



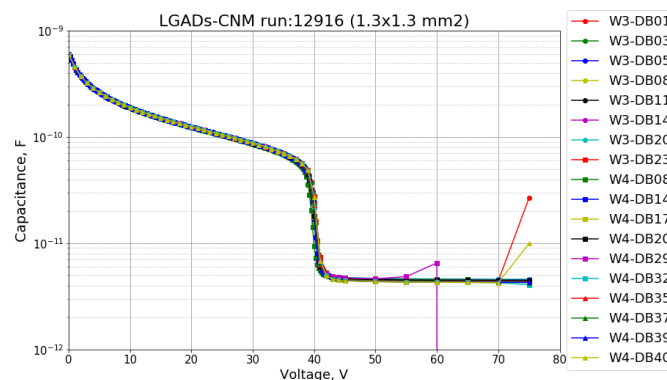
Electrical Characterizations

- Preliminary results of the sensors before irradiations

CNM – Run 12916



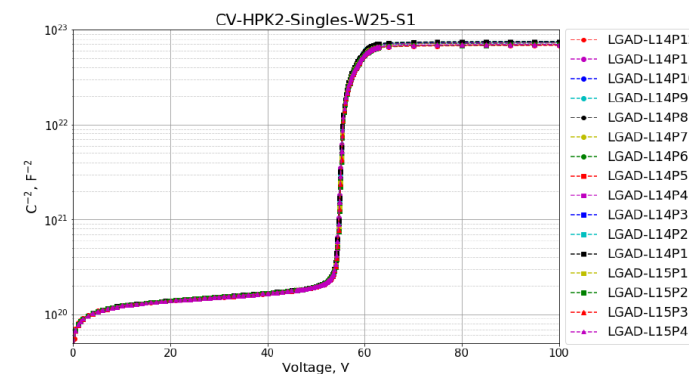
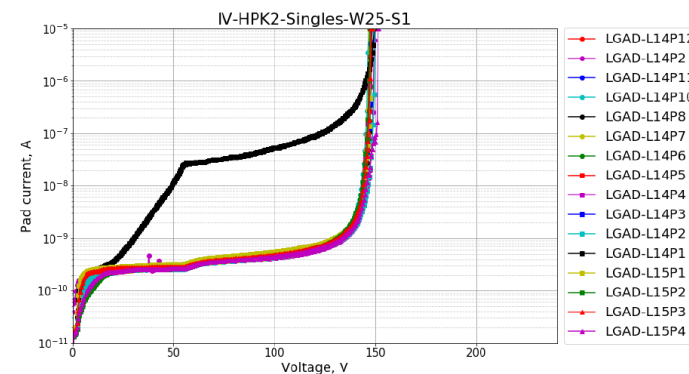
Leakage Current



Capacitance



HPK – Prototype 2

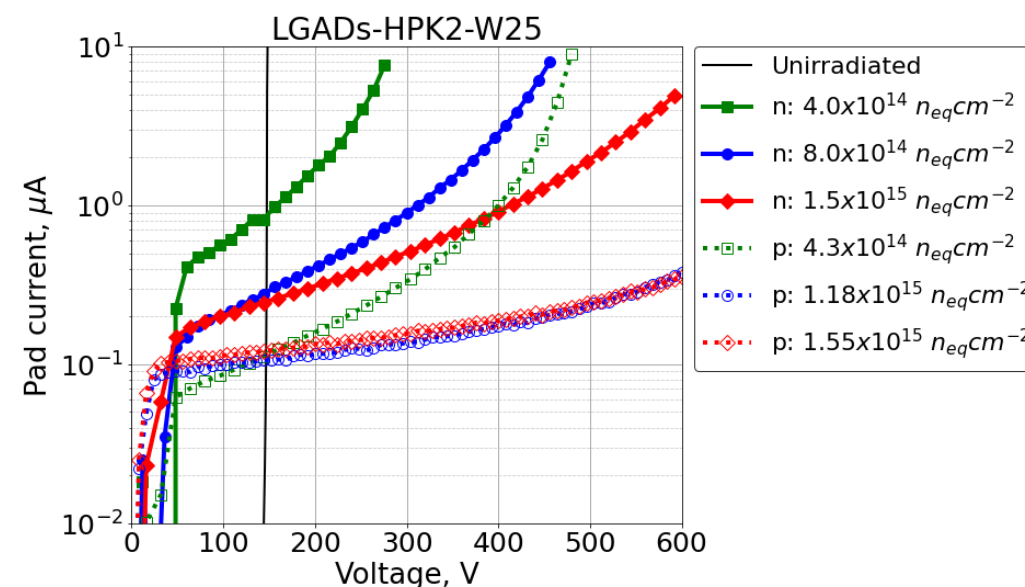
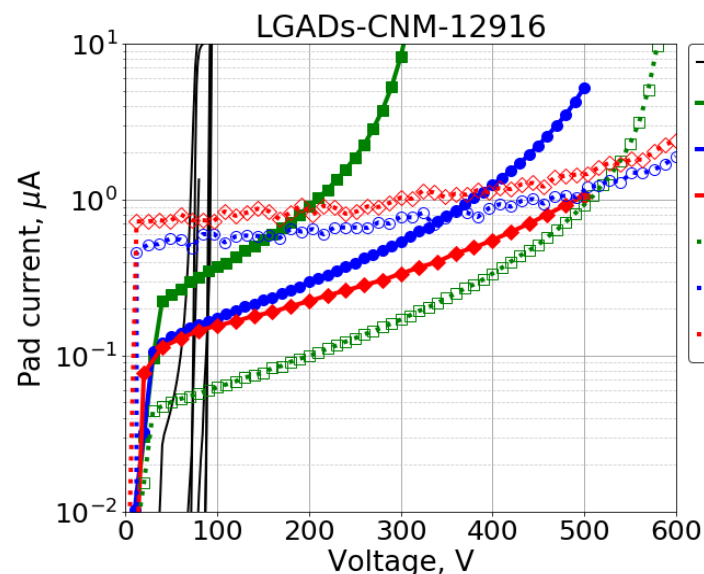


(E. Curras, EP-R&D 2021) [3]

A set of devices from these were selected for irradiation

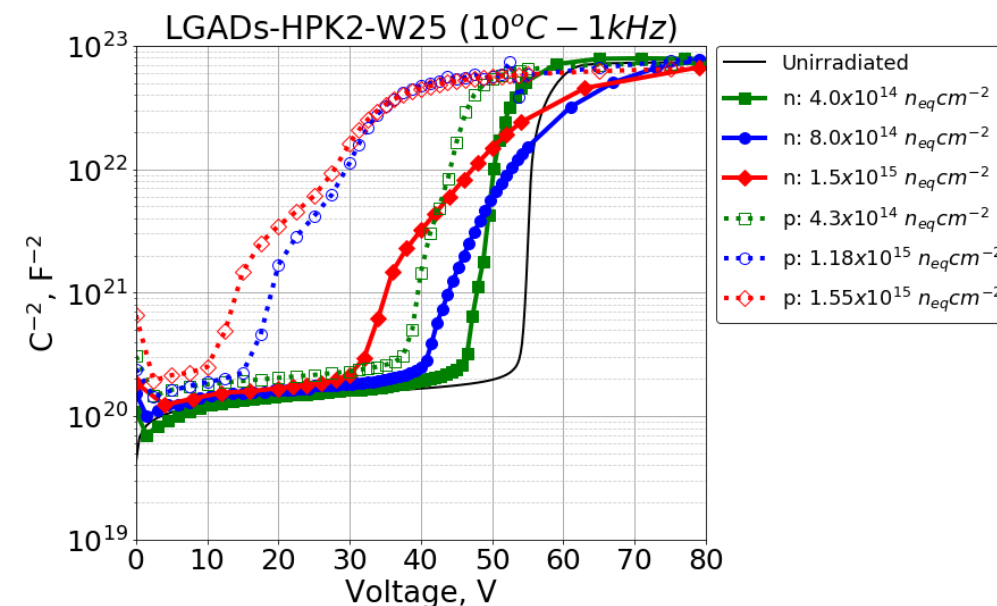
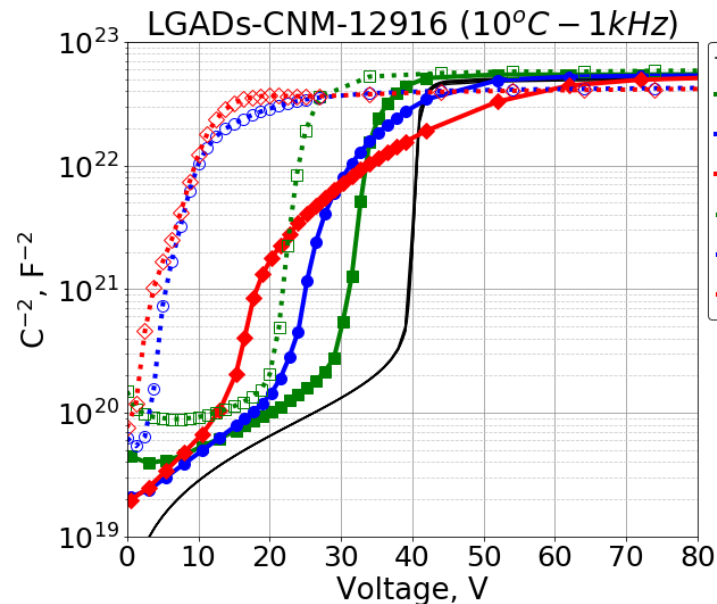
Leakage Current

- Current – Voltage characteristics **after irradiation**, measured at $T = -20^{\circ}\text{C}$



- Pad current **increases** with fluence.
- Breakdown voltage increases with fluence, the samples can be operated at **higher voltages**.
- This is already an indication that **the gain decreases** with fluence.
- Depletion voltage of the gain layer decreases, easy to see in the CV curves (next slide)
- The impact of **protons** is greater than **neutrons**: can be seen in both CNM and HPK sensors.

- Capacitance – Voltage characteristics **after irradiation**, measured at $T = 10^\circ\text{C}$ and $\text{freq} = 1\text{kHz}$.



- End capacitance **does not** change with fluence.
- Full depletion voltage **increases** with the increase in fluence.
- Depletion voltage of the gain layer decreases: indication of **less active boron** in gain layer.
- The impact of **protons** is greater than **neutrons**: can be seen in both CNM and HPK sensors.

LASER Characterizations

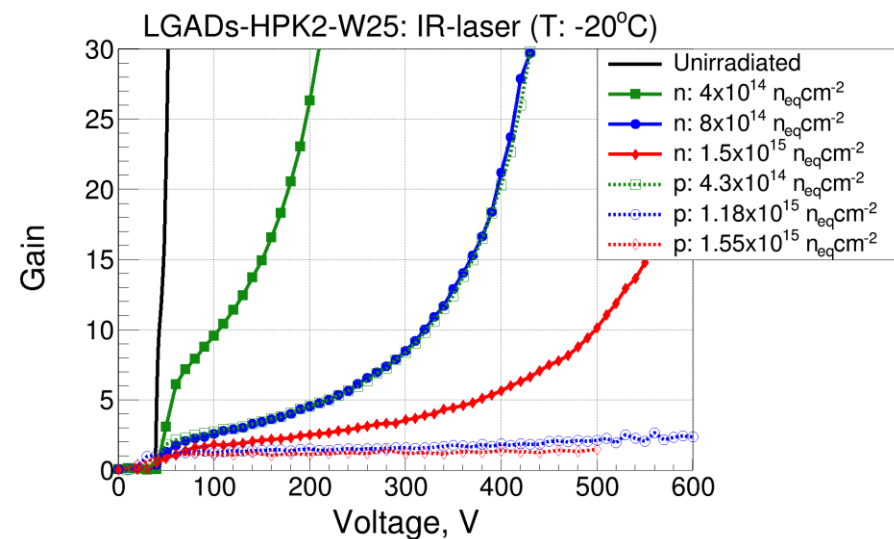
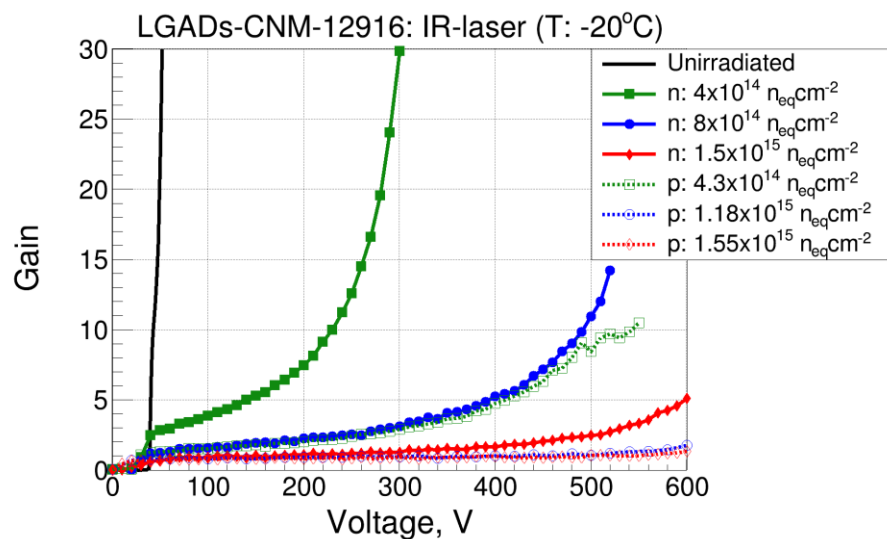
- Laser characterizations were carried out using Transient Current Technique (TCT) at SSD lab at CERN.
- Pulsed IR-Laser (1060nm) with 250ps pulse width.
- Laser intensity ~ 1 MIPs
- Calculation of gain was carried out using the following equation:

$$Gain [V] = \frac{CC_{LGAD} [V]}{CC_{PIN} [V \geq V_{FD}]}$$



Gain Measurements

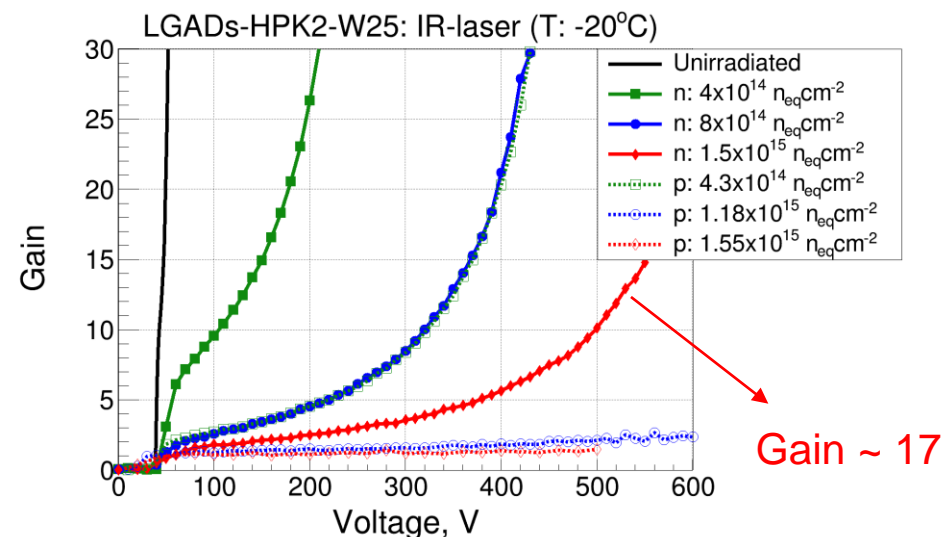
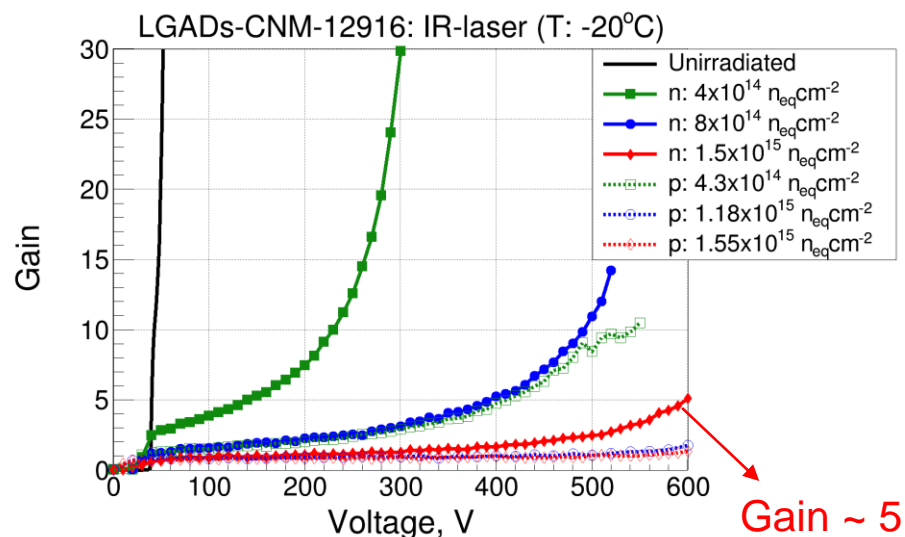
- TCT measurements taken at temp = - 20°C



- PINs, unirradiated LGADs and irradiated LGADs were measured under same conditions.
- A [reduction](#) in gain is observed with the increase in fluence.

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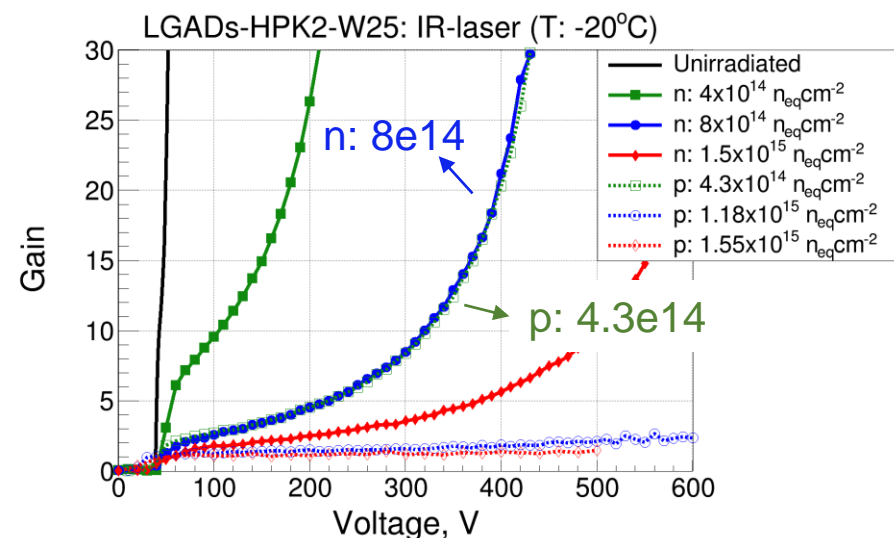
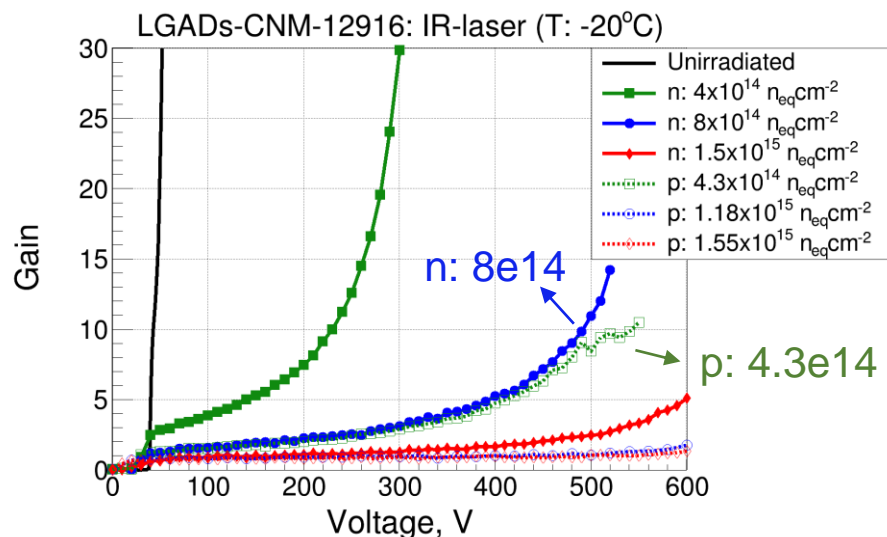
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- LGADs from HPK-P2 show greater resistance to irradiation as compared to CNM-12916.

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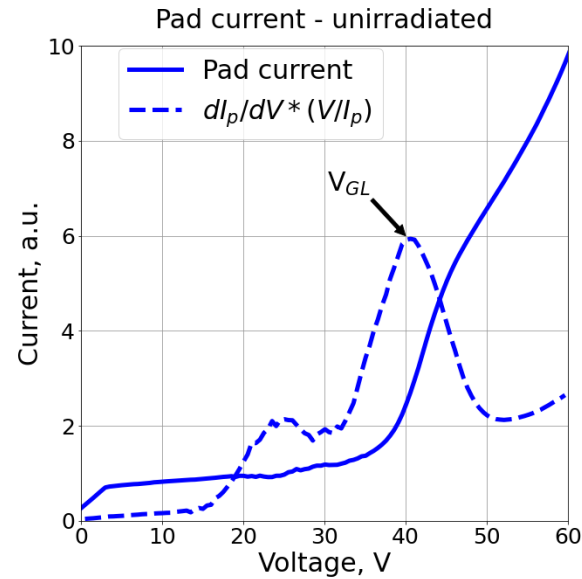
- TCT measurements taken at temp = -20°C



- PINs, unirradiated LGADs and irradiated LGADs were measured under same conditions.
- A **reduction** in gain is observed with the increase in fluence.
- LGADs from HPK-P2 show greater resistance to irradiation as compared to CNM-12916.
- Impact of 24 GeV/c protons (normalized to 1 MeV neutrons) is more than **twice** as that of neutrons for both HPK-P2 and CNM-12916.

Extraction of V_{GL}

- Three different methods to extract gain layer depletion voltage (V_{GL}) are used in this work

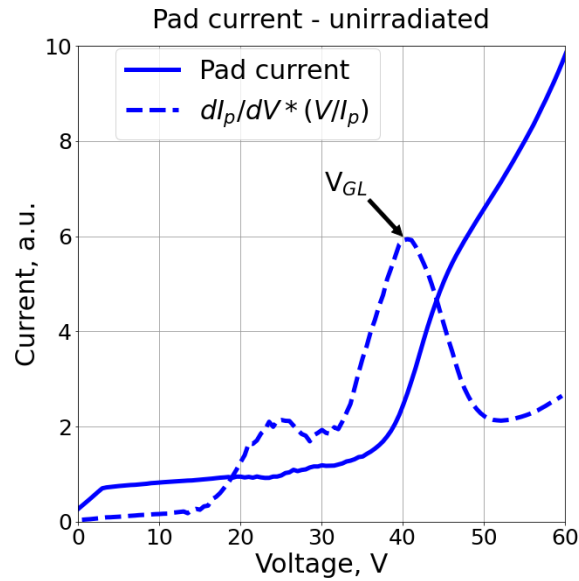


The IV method

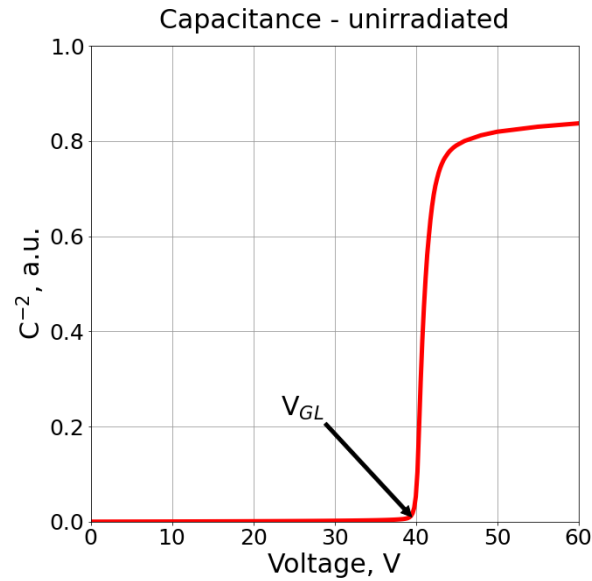
- The derivate of the pad current w.r.t voltage gives a peak around V_{GL}
- The maxima of peak can be obtained by Gaussian / Lorentzian fitting

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The IV method

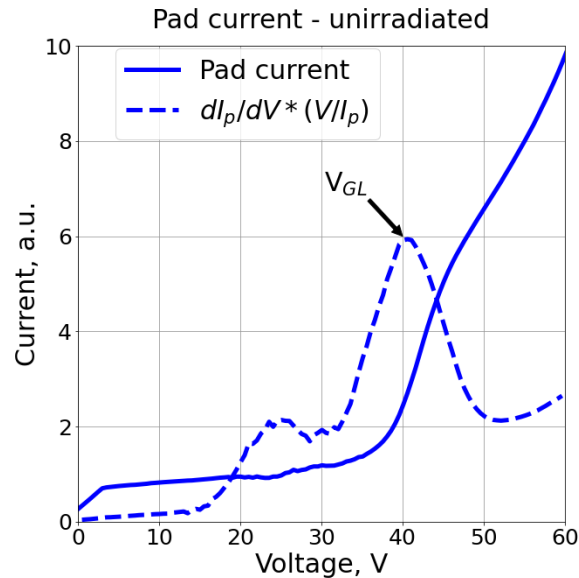


The CV method

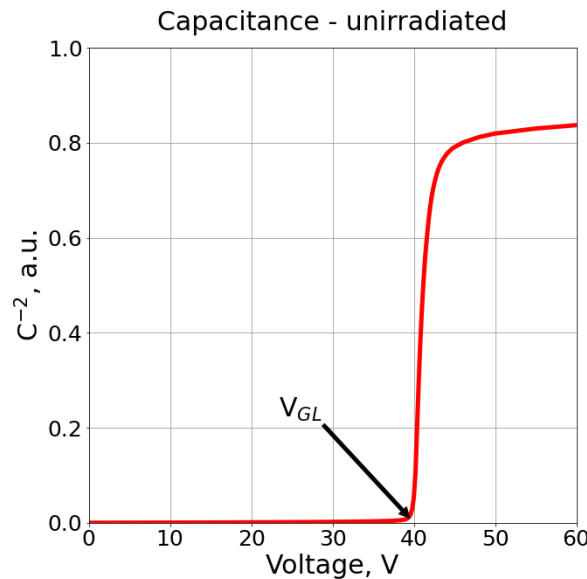
- Plotting $1/C^2$ versus voltage
- The bend represents V_{GL}

Extraction of V_{GL}

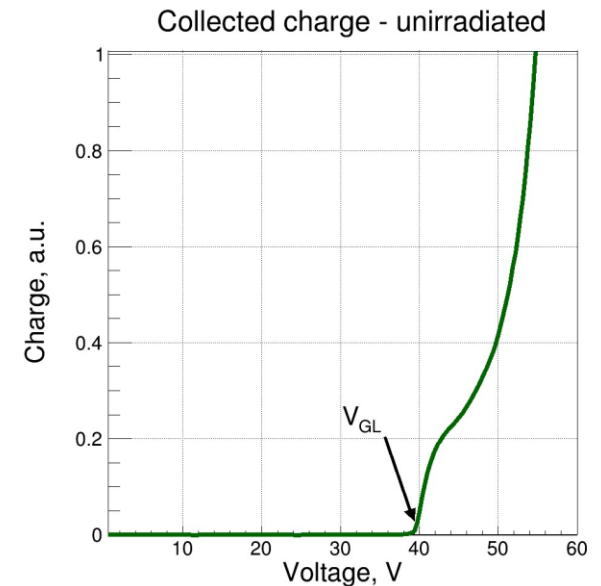
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The derivative method



The CV method

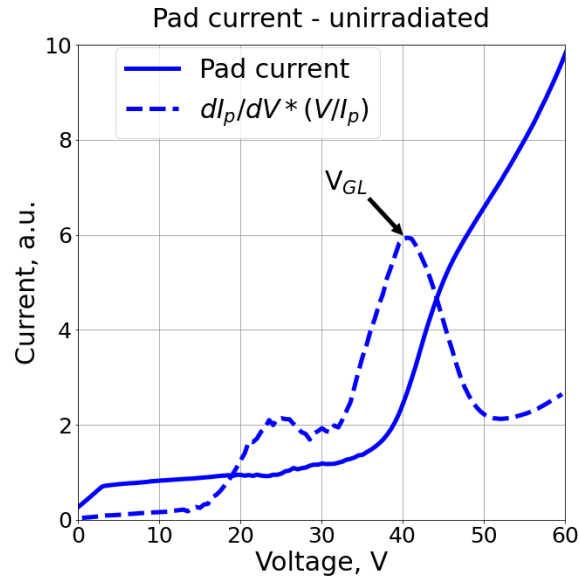


The TCT method

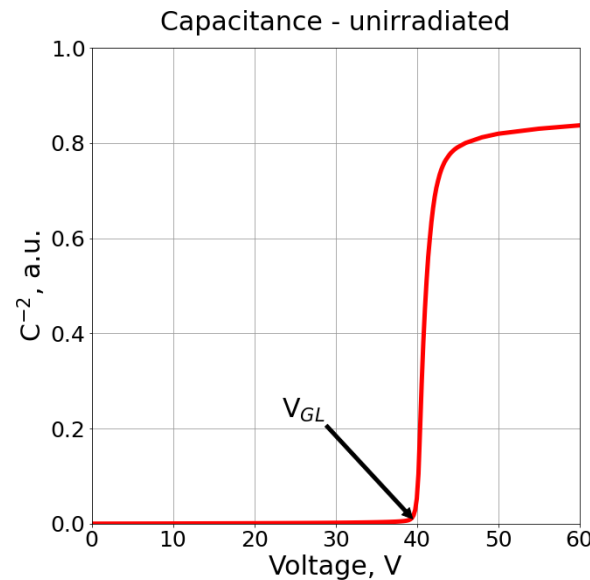
- Plotting charge collection versus voltage
- The bend represents V_{GL}

Extraction of V_{GL}

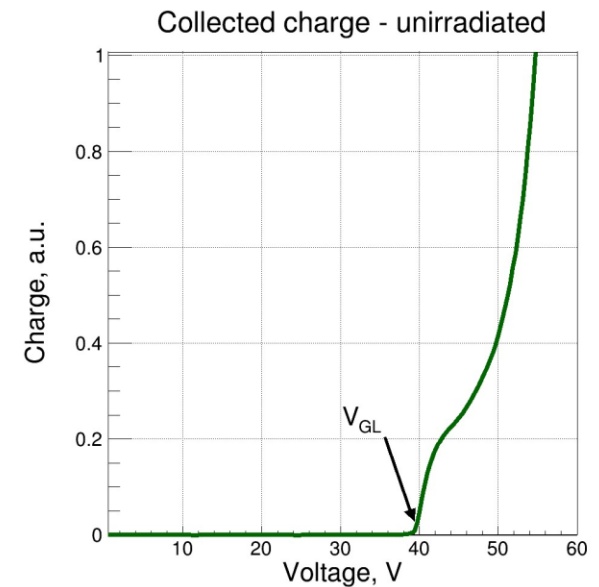
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The IV method



The CV method



The TCT method

- Before irradiation, these methods are in **good agreement** with each other.
- After irradiation, the V_{GL} extraction gets **tricky**.
- We **averaged out** the values of V_{GL} obtained from all these methods.

$$V_{GL} = \frac{V_{GL} (IV) + V_{GL} (CV) + V_{GL} (TCT)}{3}$$

Acceptor Removal Coefficient (c)

- GL fraction is calculated using the values of V_{GL} obtained by the methods explained in previous slide, where:

$$GL\ fraction = \frac{V_{GL}(\varphi)}{V_{GL}(0)}$$

- The gain layer depletion voltage at a given fluence is related to the acceptor removal coefficient 'c' by:

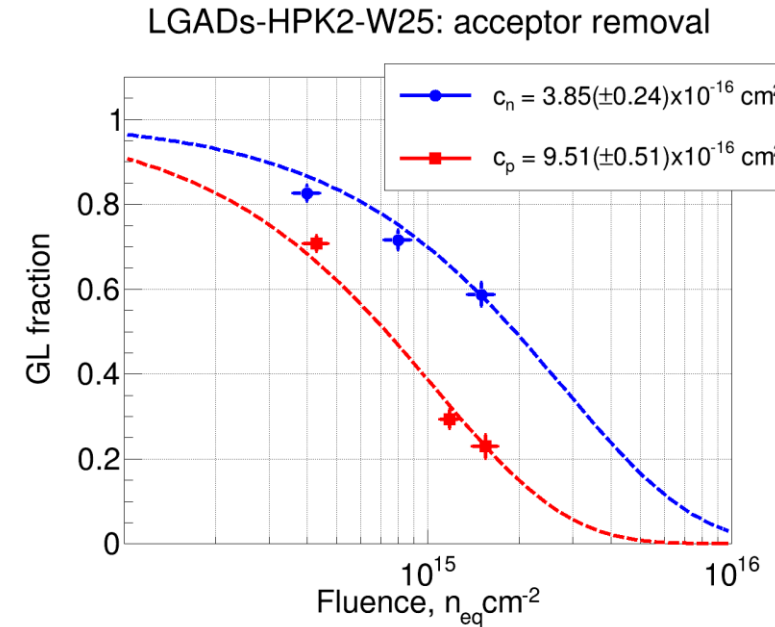
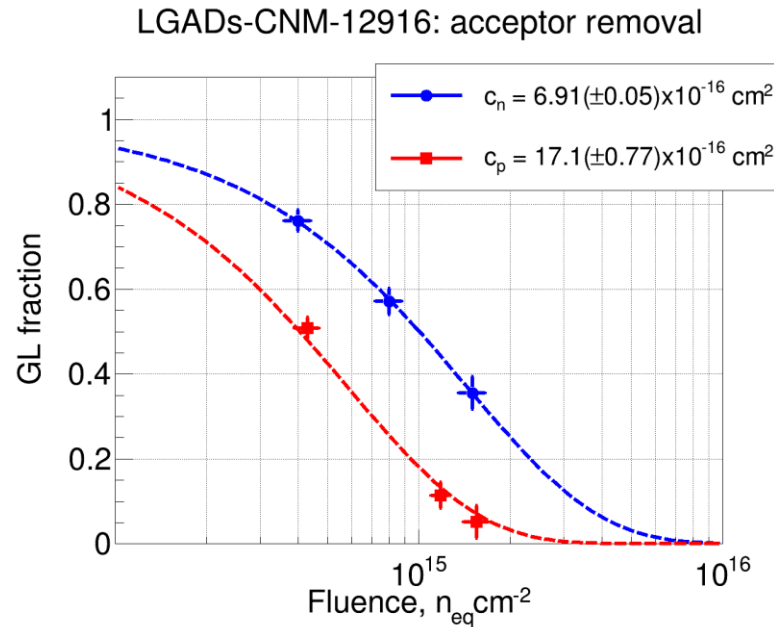
$$V_{GL}(\varphi) = V_{GL}(0) e^{-c\varphi}$$

- Acceptor removal coefficient can be obtained by fitting this equation on the V_{GL} curve versus fluence

Acceptor Removal Coefficient (c)

- GL fraction versus fluence

$$V_{GL}(\varphi) = V_{GL}(0) e^{-c\varphi}$$

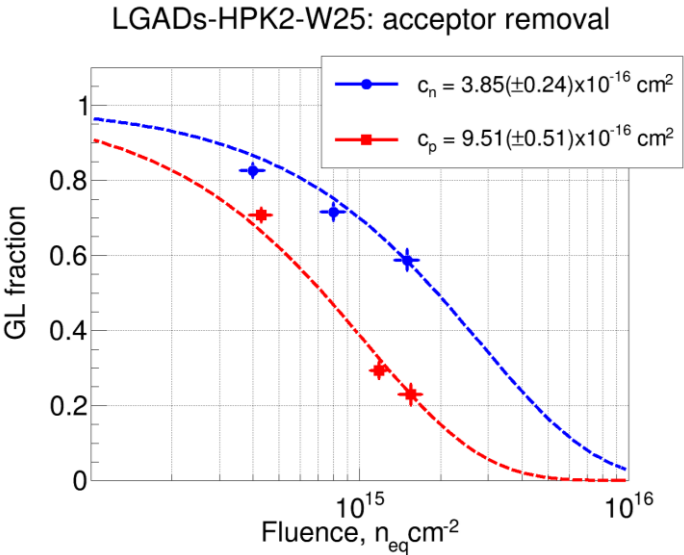
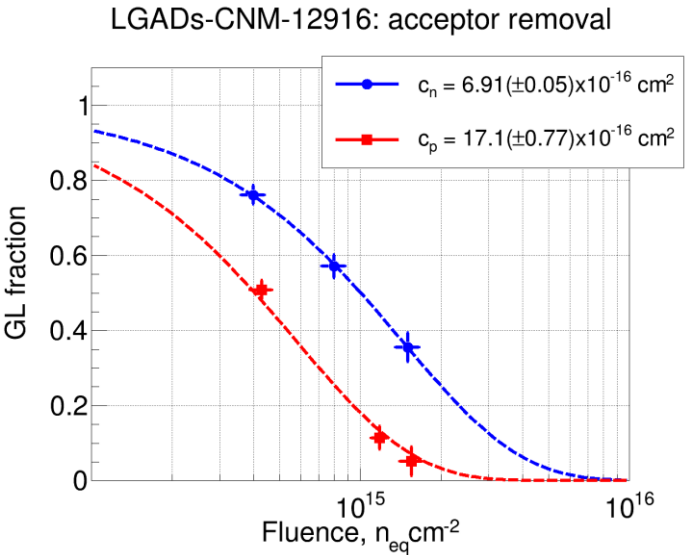


- LGADs from CNM-12916 shows higher values of 'c' as compared to HPK-P2, irrespective of irradiation type.
- This shows that degradation of gain layer also depends on shape, position, and concentration of the GL doping profile

Acceptor Removal Coefficient (c)

- 24 GeV/c protons introduce damages in gain layer almost 2.5 times higher than the neutrons, normalized to 1 MeV neutrons .
- ‘c’ value of LGADs from CNM-12916 is almost 1.8 times higher than the ones from HPK-P2 for both the proton and neutron irradiations.

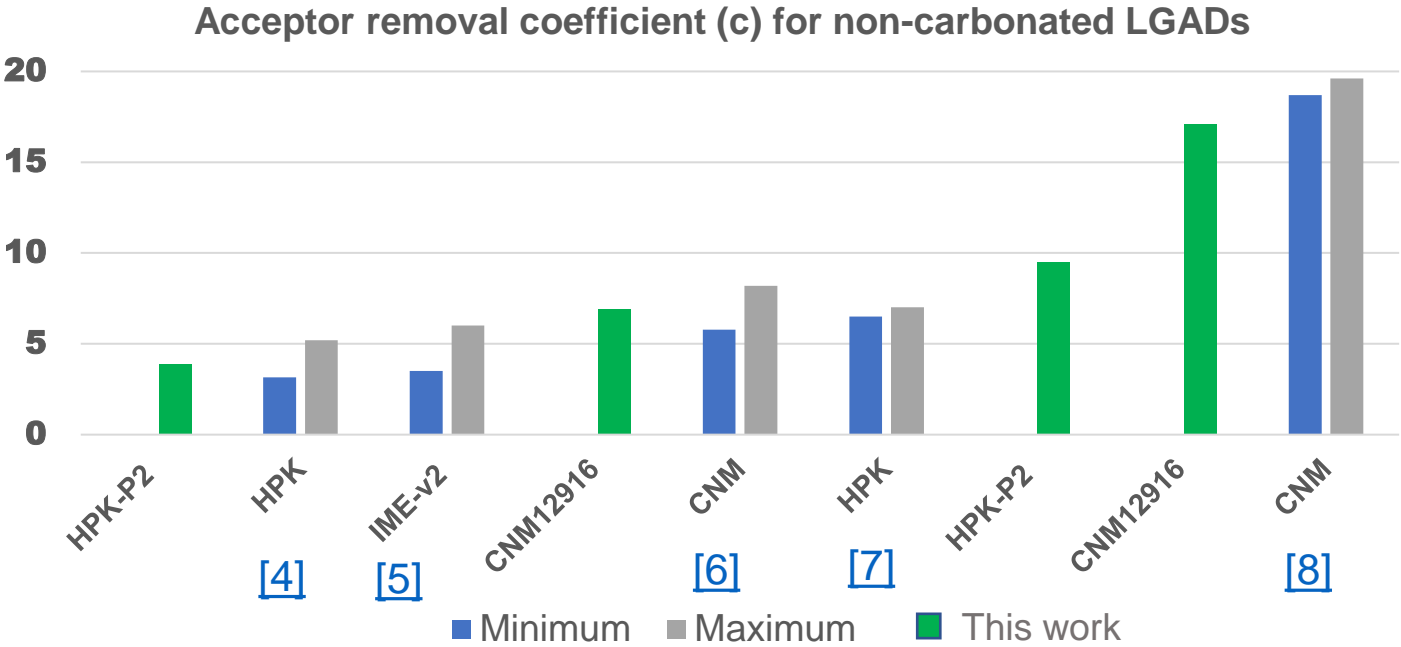
c (10 ⁻¹⁶ cm ⁻²)	c _n	c _p	c _p /c _n
CNM-12916	6.91 ± 0.05	17.1 ± 0.77	2.475
HPK-P2	3.85 ± 0.24	9.51 ± 0.51	2.470
c _{CNM} /c _{HPK}	1.795	1.798	-



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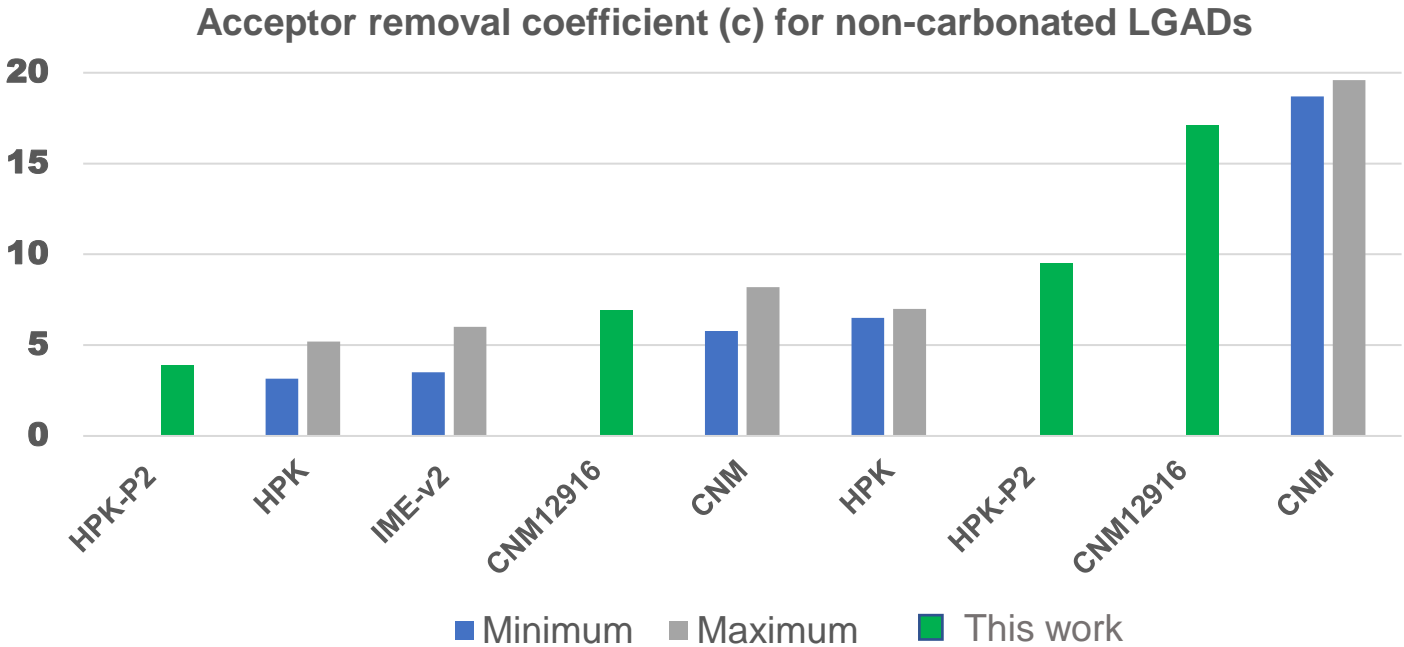
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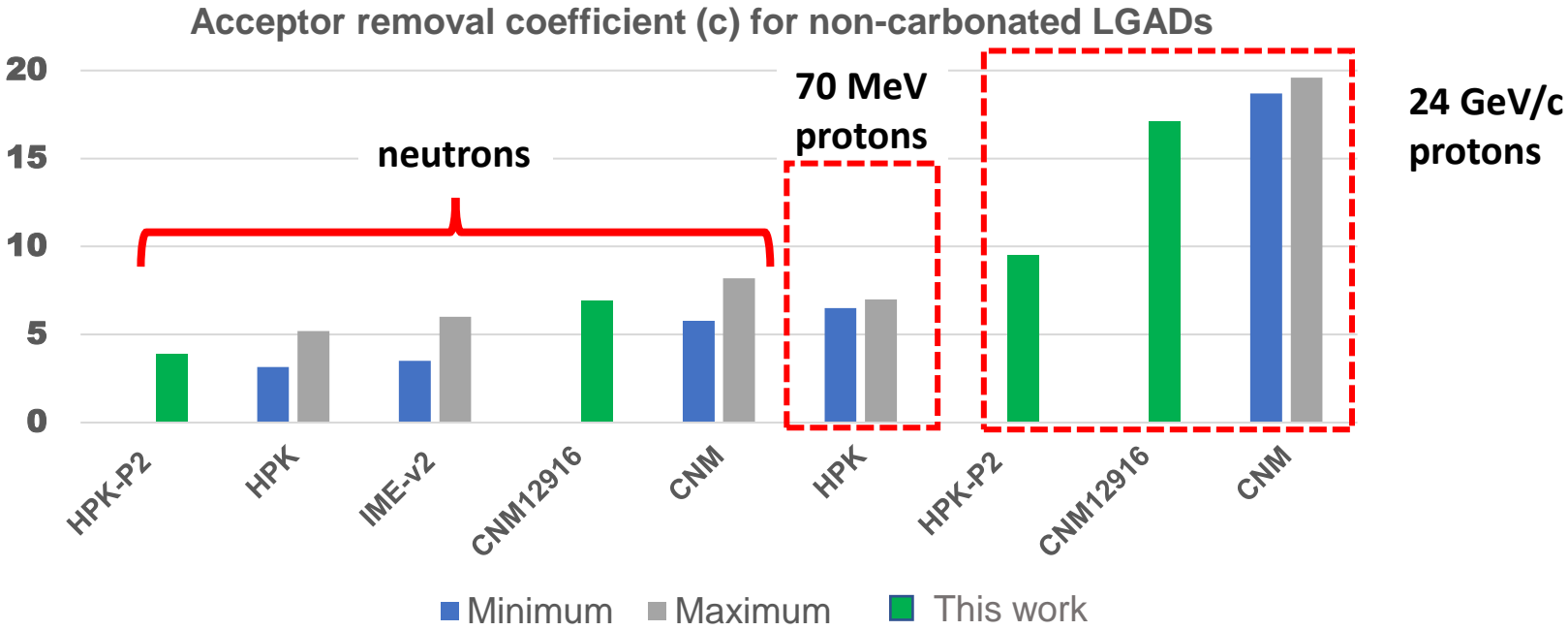


Disclaimer!
The sensors in literature are not from the same production batches

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Summary & Future Work

- Neutron and proton irradiated LGADs with different fluences from HPK-P2 and CNM-12916 were studied.
- The ratio of damage coefficient of protons to neutrons shows that 24 GeV/c protons damage the gain layer almost **2.5 times** higher than the neutrons, when normalized to 1 MeV neutrons.
- **CNM-12916 LGADs** produced with a shallow gain layer doping profile presented **more degradation** than the HPK-P2 LGADs produced with a deep and Gaussian gain layer doping profile.
- The acceptor removal constants (for protons and neutrons) gave a value for the **CNM-12916 LGADs ~ 1.8 times higher** than in the HPK-P2 ones.
- Time resolution measurements will be carried out in the next step.
- In future, the impact of long-term annealing will be studied.
- The paper is submitted to JINST, here is the link: [arXiv:2306.11760](https://arxiv.org/abs/2306.11760)

References

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3. E. Curras. Low Gain Avalanche Detectors for timing applications in high energy physics. [EP – R&D 2021](#)
4. Jin, H. Ren, S. Christie, Z. Galloway, C. Gee, C. Labitan et al., Experimental Study of Acceptor Removal in UFSD, [Nuclear Instruments and Methods in Physics Research Section A: Accelerators, Spectrometers, Detectors and Associated Equipment 983 \(2020\) 164611.](#)
5. Feng, X. Huang, C. Yu, X. Jia, S. Li, M. Li et al., Study of the Acceptor Removal Effect of LGAD, [IEEE Transactions on Nuclear Science 69 \(2022\) 2324.](#)
6. Currás et al., Timing performance and gain degradation after irradiation with protons and neutrons of low gain avalanche diodes based on a shallow and broad multiplication layer in a float-zone 35 μm and 50 μm thick silicon substrate, [Nuclear Instruments and Methods in Physics Research Section A: Accelerators, Spectrometers, Detectors and Associated Equipment \(2023\).](#)
7. Howard et al., LGAD measurements from different producers, in [37th RD50 Workshop, Zagreb, 2020.](#)
8. E. Gkougkousis, Acceptor removal - Radiation Hardness and breakdown, in [36th RD50 Workshop, Geneva, 2020.](#)

Thank you for your attention!